# GP1A30R

## Features

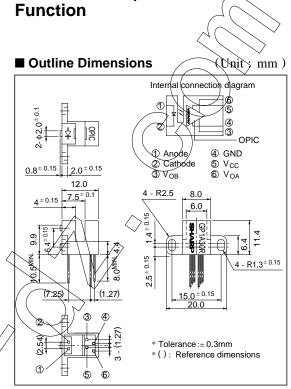
- 1. 2-phase (A, B) digital output
- 2. Possible to use plastic disk
- 3. High sensing accuracy (Disk slit pitch : 0.7mm)
- 4. TTL compatible output
- 5. Compact and light

# Applications

- 1. Electronic typewriters, printers
- 2. Numerical control machines

Absolute Maximum Ratings			(Ta= 2	5°C)	
Parameter			Rating	Unit	
Input	Forward current	IF	65	mA	
	*1Peak forward current	IFM	1	A //	
	Reverse voltage	VR	6	v//	
	Power dissipation	Р	100	mW	
Output	Supply voltage	V <sub>CC</sub>	7 /	$\overline{}$	
	Low level output current	Iol	20	mA	
	Power dissipation	Po	,250	mW	
Operating temperature		Topr	0 to + 70	°C	
Storage temperature		T <sub>stg</sub>	- 40 to + 80	°C	
*2Soldering temperature		T	-260) \	°C	
*1 Pulse width $\leq 100 \mu$ s, Duty ratio= 0.01 *2 For 5 seconds					

## Electro-optical Characteristics



**OPIC Photointerrupter with Encoder** 

\*" OPIC" (Optical IC) is a trademark of the SHARP Corporation. An OPIC consists of a light-detecting element and signalprocessing circuit integrated onto a single chip.

(Unless	otherwise	specified,	Ta = 0 to +	70°C)
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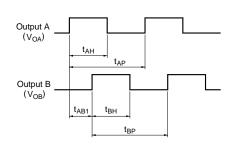
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	VF	Ta= $25^{\circ}$ C, I <sub>F</sub> = $30$ mA	-	1.2	1.5	V
	Reverse current	IR	Ta= $25^{\circ}$ C, V <sub>R</sub> = 3V	-	-	10	μΑ
Output	Operating supply voltage	Vcc		4.5	5.0	5.5	V
	High level output voltage	VOH	$^{*3}V_{CC}=5V, I_{F}=30mA$	2.4	4.9	-	V
	Low level output voltage	Vol	$^{*3}I_{OL} = 8mA, V_{CC} = 5V, I_F = 30mA$	-	0.1	0.4	V
	Suppty current	Icc	$^{*3*4}I_F= 30mA, V CC= 5V$	-	5	20	mA
Transfer charac-		*5DA	$V_{CC}=5V, I_{F}=30mA,$	20	50	80	%
		*5DB	*3f= 2.5kHz	20	50	80	%
teristics	Response frequency	f мах.	<sup>*3</sup> V <sub>CC</sub> = 5V, I <sub>F</sub> = 30mA	-	-	5	kHz

\*3 Measured under the condition shown in Measurement Conditions. \*4 In the condition that output A and B are low level.

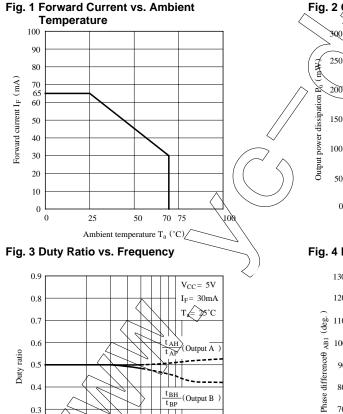
\*5  
$$D_A = \frac{t_{AH}}{t_{AP}} \ge 100, \quad D_B = \frac{t_{BH}}{t_{BP}} \ge 100$$

<sup>14</sup> In the absence of confirmation by device specification sheets, SHARP takes no responsibility for any defects that occur in equipment using any of SHARP's devices, shown in catalogs, data books, etc. Contact SHARP in order to obtain the latest version of the device specification sheets before using any SHARP's device."

# Output Waveforms



Rotational direction: Counterclockwise when seen from OPIC light detector



5

Frequency f (kHz)

10

20

Fig. 2 Output Power Dissipation vs. Ambient Temperature

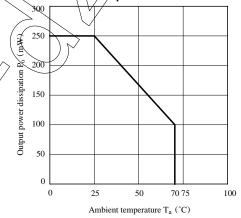
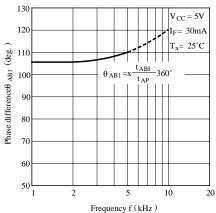
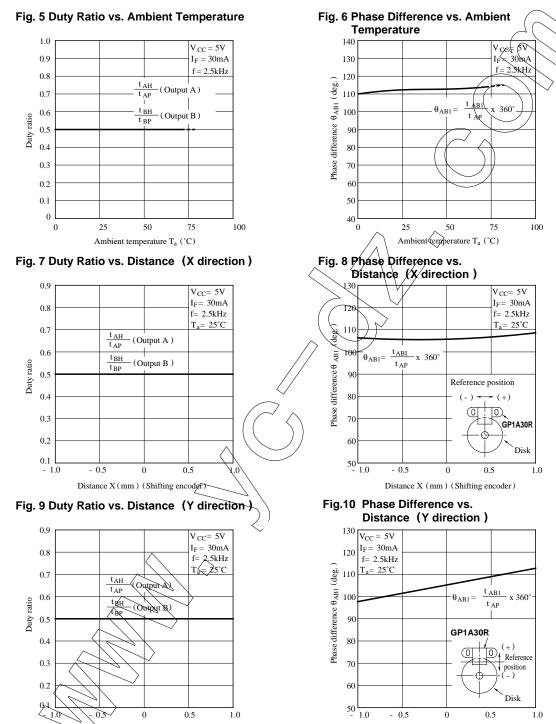


Fig. 4 Phase Difference vs. Frequency



0.2

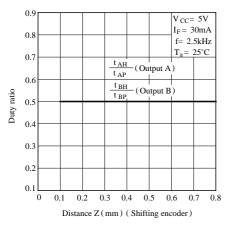
0



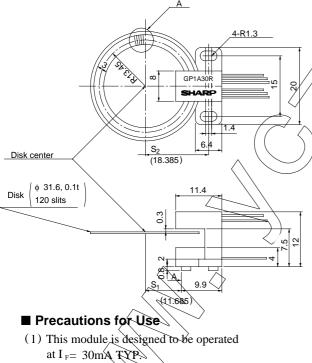
Distance Y (mm) (Shifting encoder)

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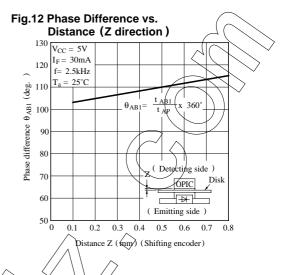
### Fig.11 Duty Ratio vs. Distance (Z direction)



## Measurement Conditions



- (2) Fixing torque: MAX. Ø.6Nm (6kgf cm)
- (3) In order to stabilize power supply line, connect a by-pass capacitor of more than 0.01µF between Vec and GND near the device.
- (4) As for other general cautions, refer to the chapter "Precautions for Use".



### ≺Basic Design⊳

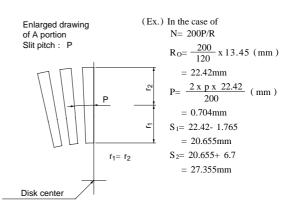
Ν

Ro (distance between the disk center and half point of a slit), P/(slit pitch), Shand S2 (installing position of photointerrupter) will be provided by the following equations. Slit pitch: P (slit center)

$$R_{O} = \frac{N}{120} \times 13.45 \text{ (mm)} \text{ N: number of slits}$$
$$P = \frac{2x \text{ p x } R_{O}}{N} \text{ (mm)}$$

 $S_1 = R_0 - 1.765 (mm), S_2 = S_1 + 6.7 (mm)$ 

Note ) When the number of slits is changed, values in parenthesis are also changed according to the number.



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